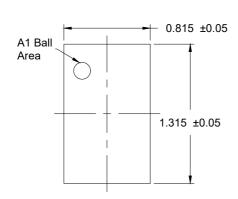


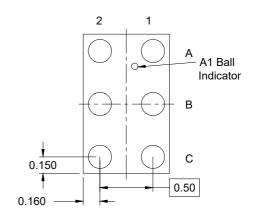


Package Code: AHR6D1

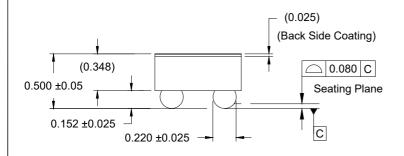
6-WLCSP 0.815 x 1.315 x 0.500 mm Body, 0.5mm Pitch PSC-4779-01, Revision: 05, Date Created:May 22, 2024



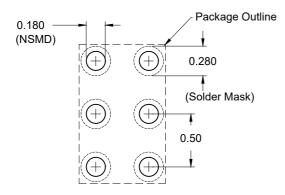
TOP VIEW



BOTTOM VIEW



SIDE VIEW



RECOMMENDED LAND PATTERN (PCB Top View, NSMD Design)

NOTES:

- 1. JEDEC compatible.
- 2. All dimensions are in mm and angles are in degrees.
- 3. Use ± 0.05 mm for the non-toleranced dimensions.
- 4. Numbers in () are for references only.
- 5. Pre-reflow solder ball diameter is Ø0.200 mm.
- 6. UBM diameter is Ø0.200 mm.